TECHNICAL DATA SHEET



AS1421-100 1 Part Non-Corrosive Neutral Cure Adhesive Sealant and Potting Material (Electronic Grade)

Description	Property	Test Method	Value
This is a heat cured, non-corrosive, neutral cure, 1-part, silicone adhesive sealant. It is one in a range of Addition cure products which are solvent free. It exhibits primerless adhesion to many substrates when cured at temperatures above 100°C. It cures to form a very tough resilient silicone elastomer. This product will not corrode copper or its alloys and is suitable for use with electronic components.	Uncured Product Appearance Cure Profile Cure Type Rheology Self Bonding		Grey paste 16 minutes at 100°C Addition Heat Cure Paste Yes
Key Features	Viscosity	Brookfield	140000 - 240000 cP
 UL94V0 recognised in file No. E334038 Excellent thermal conductivity Fast heat cure and adhesion Contains 100 micron glass beads 	Cured Product After 60 minutes at 125°C Color		Grey
Application	Density	BS ISO 2781	2.18 g/cm3
Electronics Use and Cure Information This product is a ready to use 1-Part system. It is recommended that liquid versions be thoroughly mixed prior to use, particularly thermally conductive products which are supplied in tubs or pails. Ensure that all surfaces of the substrate are clean and degreased. The work area should be free of contaminants such as organic compounds of sulphur, phosphorus, nitrogen and tin,	Elongation at Break Hardness Shore A Linear Coefficient of Thermal Expansion (ppm/°C)	ISO 37 ASTM D 2240-95	105 %
			195 ppm/°C
	Max Working Temp Min Working Temp	100.07	210 °C / 410 °F -50 °C / -58 °F
which act as catalyst poisons.	Tensile Strength	ISO 37	2.2 N/mm2 / 319 psi
The rate of cure will depend on how long it takes for the sealant to reach the required curing temperature. Small beads of 1 to 2mm diameter, used as formed-in-place gaskets, can be cured quickly	Thermal Conductivity UL 94V-0 UL File No.		2.1 W/mK Yes E334038
with hot air guns e.g. paint stripper types. With larger sections of sealant or when using as an encapsulant, cure times will increase and the use of an oven will be needed. Increasing the	Volume Coefficient of Thermal Expansion (ppm/°C)		586 ppm/°C
temperature will reduce cure times and maximum cure temperature should not exceed 200°C. All times are based on the actual time in an air-circulating oven at the stated temperature. Note: Improved adhesion is achieved by post cure at 120 to 150°C for 1 to 2 hours.	Electrical Properties Dielectric Strength (V/mil) Dielectric Strength kV/mm Volume Resistivity (Ohms	ASTM D-149	>457 V/mil >18 kV/mm / 0 V/mil
"For pneumatic dispensing of 310 ml cartridges, the	cm)	ASTM D-257	3.5E+13 ohms cm
recommended pressure is 2.25 to 3.45 bar (40 to 50 psi). Dispensing pressure above the recommended limits may lead to gas bypassing the piston, causing spluttering at the nozzle and poor bead quality"	Storage Max Storage Temperature Min Storage Temperature		10 °C / 50 °F -5 °C / 23 °F
Health & Safety	Shelf Life		12 mths
Health and Safety			
Safety Data Sheets available on request.			
Packaging			

CHT Adhesives are available in a variety packaging including cartridges and bulk containers. Please contact our sales department for more information.

Revision Date	12 Feb 2024
Revision No	3
Download Date	02 May 2024

The content set out in the technical data sheet does not contain information upon which you should rely. It is provided for general information purposes only and does not constitute a product specification. You must obtain professional or specialist advice before taking any action based on the information provided in the technical data sheet. CHT make reasonable efforts to ensure that information set out in the technical data sheet is complete, accurate, and up-to-date. CHT do not, however, make any representations, warranties or

CHT make reasonable efforts to ensure that information set out in the technical data sheet is complete, accurate, and up-to-date. CHT do not, however, make any representations, warranties or guarantees (whether express or implied) that information set out in the technical data sheet is complete, accurate, or up-to-date or that the product will be suitable for your requirements. You should carry out your own testing to determine the applicability of such information and whether the product will be suitable. CHT reserve the right to modify the technical data sheet at any time. The CHT technical service department is available to offer further information and advice and should it be needed to look at modifying current products or custom formulate a new one to meet your specific requirements. Please contact the technical service department.

CHT Germany GmbH: Postfach 12 80, 72002 Tübingen, Bismarckstraße 102, 72072 Tübingen, Germany

Telephone: 07071/154-0, Fax: 07071/154-290, Email: info@cht.com, Homepage: www.cht.com / www.cht-silicones.com